# **One Watt High Current Transistors**

# **NPN Silicon**

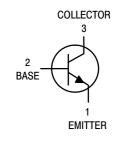
## Features

• Pb-Free Packages are Available\*



# **ON Semiconductor®**

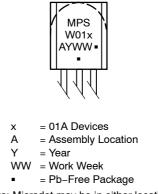
http://onsemi.com





TO-92 (TO-226AE) CASE 29-10 STYLE 1

## MARKING DIAGRAM



(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

**MAXIMUM RATINGS** Symbol Rating Value Collector - Emitter Voltage  $V_{CEO}$ MPSW01 30 MPSW01A 40 Collector - Base Voltage V<sub>CBO</sub> MPSW01 40 MPSW01A 50 Emitter-Base Voltage 5.0 **V**EBO Collector Current - Continuous 1000 I<sub>C</sub>

Derate above 25°C		8.0	
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	2.5 20	
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	

Рп

1.0

## THERMAL CHARACTERISTICS

Total Device Dissipation @  $T_{\Lambda} = 25^{\circ}C$ 

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	125	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	50	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Unit

Vdc

Vdc

Vdc

mAdc

W mW/°C W mW/°C

°C

# MPSW01, MPSW01A

## **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = $25^{\circ}$ C unless otherwise noted)

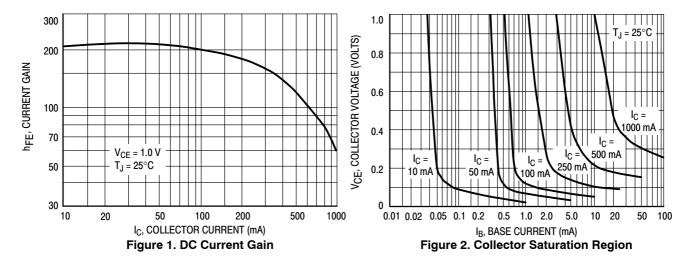
Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					•
Collector – Emitter Breakdown Voltage (Note 1) (I <sub>C</sub> = 10 mAdc, I <sub>B</sub> = 0) MPSW01 MPSW01A		V <sub>(BR)CEO</sub>	30 40		Vdc
Collector – Base Breakdown Voltage (I <sub>C</sub> = 100 μAdc, I <sub>E</sub> = 0) MPSW01 MPSW01A		V <sub>(BR)CBO</sub>	40 50		Vdc
Emitter – Base Breakdown Voltage ( $I_E = 100 \ \mu Adc$ , $I_C = 0$ )		V <sub>(BR)EBO</sub>	5.0	-	Vdc
Collector Cutoff Current $(V_{CB} = 30 \text{ Vdc}, I_E = 0)$ $(V_{CB} = 40 \text{ Vdc}, I_E = 0)$	MPSW01 MPSW01A	I <sub>CBO</sub>		0.1 0.1	μAdc
Emitter Cutoff Current (V <sub>EB</sub> = 3.0 Vdc, I <sub>C</sub> = 0)		I <sub>EBO</sub>	_	0.1	μAdc
ON CHARACTERISTICS (Note 1)					
DC Current Gain (I <sub>C</sub> = 10 mAdc, V <sub>CE</sub> = 1.0 Vdc) (I <sub>C</sub> = 100 mAdc, V <sub>CE</sub> = 1.0 Vdc) (I <sub>C</sub> = 1000 mAdc, V <sub>CE</sub> = 1.0 Vdc)		h <sub>FE</sub>	55 60 50		-
Collector – Emitter Saturation Voltage ( $I_C$ = 1000 mAdc, $I_B$ = 100 mAdc)		V <sub>CE(sat)</sub>	-	0.5	Vdc
Base-Emitter On Voltage (I <sub>C</sub> = 1000 mAdc, V <sub>CE</sub> = 1.0 Vdc)		V <sub>BE(on)</sub>	-	1.2	Vdc
SMALL-SIGNAL CHARACTERISTICS				•	•
Current – Gain — Bandwidth Product (I <sub>C</sub> = 50 mAdc, V <sub>CE</sub> = 10 Vdc, f = 20 MHz)		f <sub>T</sub>	50	-	MHz
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)		C <sub>obo</sub>	_	20	pF

1. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

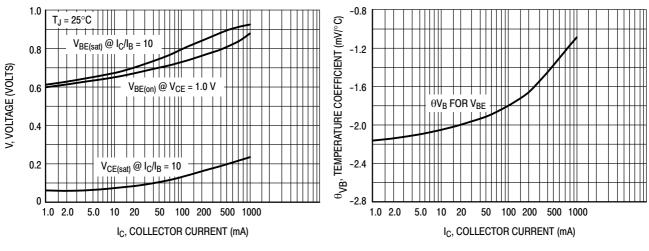
#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MPSW01	TO-92	5000 Units / Bulk
MPSW01G	TO-92 (Pb-Free)	5000 Units / Bulk
MPSW01AG	TO-92 (Pb-Free)	5000 Units / Bulk
MPSW01ARLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
MPSW01ARLRPG	TO-92 (Pb-Free)	2000 / Tape & Ammo Box

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



# MPSW01, MPSW01A







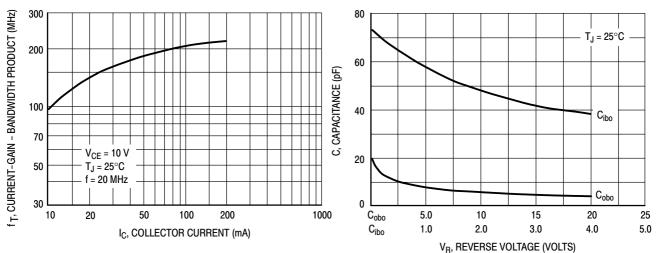


Figure 5. Current Gain — Bandwidth Product

Figure 6. Capacitance

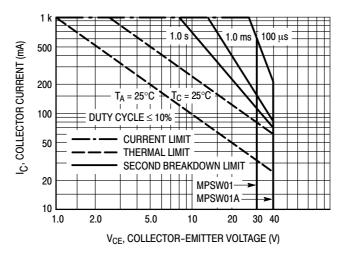
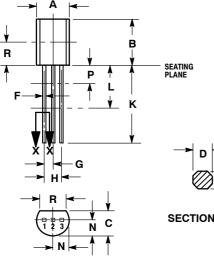


Figure 7. Active Region — Safe Operating Area

#### PACKAGE DIMENSIONS

TO-92 (TO-226AE) CASE 29-10 **ISSUE AL** 







#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH. 3. CONTOUR OF PACKAGE BEYOND DIMENSION R
- IS UNCONTROLLED. 4. DIMENSION F APPLIES BETWEEN P AND L DIMENSIONS D AND J APPLY BETWEEN L AND K MIMIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.44	5.21
В	0.290	0.310	7.37	7.87
С	0.125	0.165	3.18	4.19
D	0.018	0.021	0.457	0.533
F	0.016	0.019	0.407	0.482
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.018	0.024	0.46	0.61
Κ	0.500		12.70	
L	0.250		6.35	
Ν	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.135		3.43	

STYLE 1: PIN 1. EMITTER

BASE 2. 3. COLLECTOR

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